TOSHIBA

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC7MP245FK, TC7MP245FTG

Low-Voltage/Low-Power Octal Bus Transceiver with Bus-hold

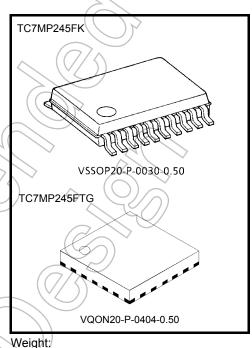
The TC7MP245 is a high-performance CMOS octal bus transceiver. By a low power consumption circuit, power

consumption has been reduced when a bus terminal is disable state (OE=High).

The direction of data transmission is determined by the level of the DIR input. The OE input can be used to disable the device so that the busses are effectively isolated.

But, bus of a B bus side at floating state is maintained in an appropriate logic level due to a bus hold circuit to a B bus. Moreover, the bus-hold circuit which is added to a B bus is off when \overline{OE} is low.

All inputs are equipped with protection circuits against static discharge.



VSSOP20-P-0030-0.50 : 0.03 g (typ.) VQON20-P-0404-0.50 : 0.0145 g (typ.)

Features

- : V_{CC} = 1.65 to 3.6 V Low-voltage operation
- : By a new input circuit, power consumption in OE=H is reduced largely. Low power current consumption

assistant or a cellular phone.

It is most suitable for battery drive products such as personal digital

- Quiescent supply current
- High-speed operation

 t_{pd} = 3.0 ns(max) (V_{CC}=3.3±0.3V) t_{pd} = 4.6 ns (max) (V_{CC}=2.5±0.2V)

 $I_{CC} = 5 \,\mu A \,(max) \,(V_{CC} = 3.6 V)$

t_{pd} = 10.0 ns (max) (V_{CC}=1.8±0.15V) Output current

 I_{OHA}/I_{OLA} (A bus) = ±12mA (min) (V_{CC}=3.0V)

 $: I_{OHB}/I_{OLB}$ (B bus) = ±24mA (min) (V_{CC}=3.0V)

- Latch-up performance
- ESD performance

Machine model ≥ ±200 V Human body model $\geq \pm 2000 \text{ V}$

- Ultra-small package : VSSOP(US20), VQON20
- Bus hold circuit is built in only the B bus side.(Only in OE=H, a former state is maintained.)
- Floating of A-bus and B-bus are permitted.(When OE=H)
- Gate IC for control(TC7MP01FK) of DIR and OE terminal are prepared.

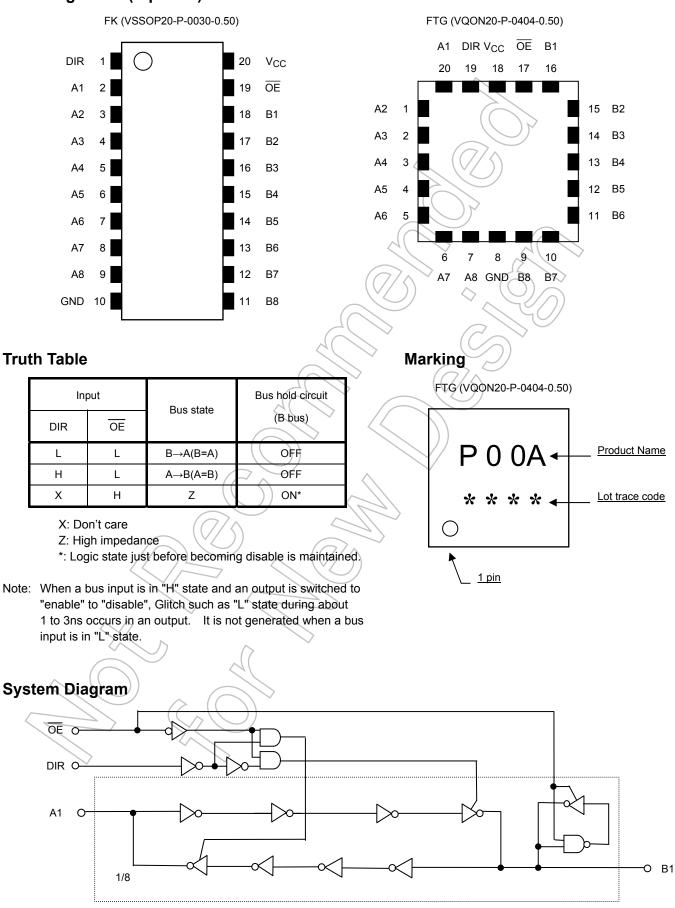
: ±300mA

3.6V tolerant function provided on A-bus terminal, DIR and OE terminal.

Note 1: At the time bus terminal is enable state, please do not give a signal from the outside.

Note 2: When mounting VQON package, the type of recommended flux is RA or RMA.

Pin Assighment (top view)



Absolute Maximum Ratings (Note 1)

Parameter	Symbol	Rating	Unit
Power supply voltage	V _{CC}	-0.5 to 4.6	V
DC input voltage (DIR, OE)	V _{IN}	-0.5 to 4.6	V
DC input/output voltage(A bus)	Much	-0.5 to 4.6 (Note 2)	v
DC input/output voltage(A bus)	V _{I/OA}	-0.5 to V _{CC} +0.5 (Note 3)	× V
DC input/output voltage(B bus)	V _{I/OB}	-0.5 to V _{CC} +0.5	N(
Input diode current(DIR, OE)	IIIK	-50	mA
Input/Output diode current	II/OK	±50	mA
Output current	IOUT	±50	mA
DC VCC/ground current	I _{CC} /I _{GND}	±100	mA
Power dissipation	PD	180	mW
Storage temperature	Tstg	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: V_{CC}=0V, or output off state.

Note 3: OE="L", DIR="L"

Operating Ranges (Note 1)

Parameter	Symbol	Rating	Unit
Power supply voltage) v _{cc}	1.65 to 3.6	V
Tower supply voltage	VCC	1.2 to 3.6 (Note 2)	v
DC input voltage (DIR, OE)	VIN	-0.3 to 3.6	V
DC input/output voltage(A bus)	VI/OA	0 to 3.6 (Note 3)	V
De inpurouput voltage(A bus)	AU/JA	0 to V _{CC} (Note 4)	v
DC input/output voltage(B bus)	VI/OB	0 to V _{CC}	V
		±12 (Note 5)	
Output current (A bus)	IOHA/IOLA	±9 (Note 6)	mA
	\sim	±2 (Note 7)	
		±24 (Note 5)	
Output current (B bus)	IOHB/IOLB	±18 (Note 6)	mA
	\sim	±4 (Note 7)	
Operating temperature	Topr	-40 to 85	°C
Input rise and fall time	dt/dv	0 to 10 (Note 8)	ns/V

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs and bus inputs must be tied to either V_{CC} or GND. Please connect both bus inputs and the bus outputs with V_{CC} or GND when the I/O of the bus terminal changes by the function. In this case, please note that the output is not short-circuited.

Note 2: Data retention only

- Note 3: V_{CC}=0V, or output off state
- Note 4: OE="L", DIR="L"
- Note 5: V_{CC}=3.0 to 3.6V
- Note 6: V_{CC}=2.3 to 2.7V
- Note 7: V_{CC}=1.65 to 1.95V
- Note 8: V_{IN}=0.8 to 2.0V, V_{CC}=3.0V

Electrical Characteristics

DC Characteristics (Ta=-40 to 85°C, 2.7V<V_{CC} \leq 3.6V)

Parameter		Symbol	Test	Condition	V _{CC} (V)	Min	Max	Unit	
	H-level	V _{IH}		-	2.7 to 3.6	2.0	-	N	
DC input voltage	L-level	V _{IL}		-	2.7 to 3.6	<u>}-</u>	0.8	V	
				I _{OHA} =-100uA	2.7 to 3.6	V _{CC} -0.2			
		Vous	$\lambda (\dots - \lambda (\dots $	I _{OH} =-6mA	2.7	2.2	-		
	H-level	V _{0HA}	V _{IN} = V _{IH}	I _{OH} =-9mA	3.0 ((2,4	-		
Output voltage				I _{OH} =-12mA	3.0	2.2	-	V	
(A bus)				I _{OLA} =100uA	2.7 to 3.6	- 5	0.2	v	
	L-level	Maria	V _{IN} = V _{IL}	I _{OL} =6mA	2.7	-	0.4		
	L-level	V _{0LA}	VIN- VIL	I _{OL} =9mA 🔇	3.0	- ~	0.4		
				I _{OL} =12mA	3.0	- 2	0.55		
				I _{OHB} =-100uA	2.7 to 3.6	V _{CC} -0.2	<u> </u>		
	H-level	N	V _{IN} = V _{IH}	I _{OHB} =-12mA	2.7	2.2	0)-	V	
		V _{0HB}		I _{OHB} =-18mA	3.0	2.4	<u> </u>		
Output voltage				I _{OHB} =-24mA	3.0	2,2	-		
(B bus)	L-level	V _{0LB}	VINEVIL	IOLB=100uA	2.7 to 3.6	<u> </u>	0.2		
				I _{OLB} =12mA	2.7)) -	0.4		
			VIN-VIL	I _{OLB} =18mA	3.0	-	0.4		
			I _{OLB} =24mA		3.0	-	0.55		
Input leakage currer	nt(DIR,/OE)	I _{IN}	V _{IN} = 0 to 3.6 V		2.7 to 3.6	-	±5.0	μA	
Power off leakage	e current	IOFF	A,DIR,/OE= 0 to 3.6 V		0	-	5.0	μA	
3-state output off-st	ato ourront	loza	V _{INA} = V _{IH} or V _{IL} V _{out} = 0 to 3.6V		2.7 to 3.6	-	±5.0	μA	
		Іозв		V _{IH} or V _{IL}	2.7 to 3.6	-	±5.0	μA	
Quiescent supply current		Icc	VIN= VCC or GND		2.7 to 3.6	-	5.0	μA	
Increase in ICC per input		Δlcc	V _{IN} = V _{CC} - 0.6 V (per input)		2.7 to 3.6	-	750	μA	
Bushold input mini	mum drive			= 0.8 V	3.0	75	-		
hold curre		IIHOLD	VIN	= 2.0 V	3.0	-75	-	μA	
Bushold input over-c	trive current		V _{IN} =	: "L"→"H"	26	-	550		
to change state	- ((liod) V _{IN} =	: "H"→"L"	3.6	-	-550	μA	

Note: It is a necessary electric current to change the input in "L" or "H".

TOSHIBA

DC Characteristics (Ta=-40 to 85°C, $2.3V \le V_{CC} \le 2.7V$)

Paramete	r	Symbol	Test	Condition	V _{CC} (V)	Min	Max	Unit				
	V _{IH}		-	2.3 to 2.7	1.6	-	v					
DC input voltage	L-level	V _{IL}		-	2.3 to 2.7	~ -	0.7	v				
				I _{OHA} =-100uA	2.3 to 2.7	V _{CC} -0.2	-					
	H-level	Maria	V _{IN} = V _{IH}	I _{OHA} =-3mA	2.3	(2.0)						
	n-level	V _{0HA}	VIN- VIH	I _{OHA} =-6mA	2.3	1.8	-					
Output voltage (A bus)				I _{OHA} =-9mA	2.3	1,7	-	V				
(7 (500)				I _{OLA} =100uA	2.3 to 2.7	9.	0.2					
	L-level	V _{0LA}	V _{IN} = V _{IL}	I _{OLA} =6mA	2.3	- \	0.4					
				I _{OLA} =9mA	2.3	- ,	0.6					
						I _{OHB} =-100uA <	2.3 to 2.7	V _{CC} -0.2	\bigcirc			
		V _{0HB}	V _{IN} = V _{IH}	I _{OHB} =-6mA	2,3	2.0	<u> </u>					
	H-level			I _{OHB} =-12mA	2.3	1.8	<u> </u>					
Output voltage (B bus)				I _{OHB} =-18mA	2.3	NY Y	())-	V				
(1 503)								I _{OLB} =100uA	2.3 to 2.7	7	0.2	
	L-level	V _{0LB}	$V_{IN} = V_{IL}$	I _{OLB} =12mA	2.3	$\langle \rangle$	0.4					
			G	IOLB=18mA	2.3	<u> </u>	0.6					
Input leakage currer	nt(DIR,/OE)	l _{IN}	V _{IN} = 0 to 3.6 V		2.3 to 2.7)) -	±5.0	μA				
Power off leakage	e current	I _{OFF}	A,DIR,/C	DE=0 to 3.6 V	0	-	5.0	μA				
3-state output off-st	ate current	I _{OZA}		■V _{IH} or V _{IL} =0 to 3.6V	2.3 to 2.7	-	±5.0	μΑ				
5-state output on-st		Іодв	V _{INB} =V _{IH} or V _{IL} Vout=0 or V _{CC}		2.3 to 2.7	-	±5.0	μΑ				
Quiescent supply	lec	V _{IN} =V	CC or GND	2.3 to 2.7	-	5.0	μΑ					
Bushold input minimum drive			VIN	1= 0.7 V		45	-					
hold curren		IIHOLD	VIN	j= 1.6 V	2.3	-45	-	μA				
Bushold input over-d	Irive current	l	VIN	: "L"→"H"	0.7	-	400					
to change state	(Note)		V _{IN} =	: "H"→"L"	2.7	-	-400	μA				

Note: It is a necessary electric current to change the input in "L" or "H".



DC Characteristics (Ta=-40 to 85°C, 1.65V \leq V_{CC}<2.3V)

Parameter		Symbol	Test	Condition	V _{CC} (V)	Min	Max	Unit
	H-level	VIH		-	1.65 to 2.3	V _{CC} ×0.7	-	V
DC input voltage	L-level	V _{IL}		-	1.65 to 2.3	~	V _{CC} ×0.2	v
	H-level	Marris	VIN= VIH	I _{OHA} =-100uA	1.65	V _{CC} -0.2	-	
Output voltage	n-ievei	V _{0HA}	VIN- VIH	I _{OHA} =-2mA	1.65	(1.3)	> -	
(A bus)	L-level	V _{0LA}	V _{IN} = V _{IL}	I _{OLA} =2mA	1.65		0.2	V
		M		I _{OHB} =-100uA	1.65	V _{CC} -0.2	-	
Output voltage	H-level	V _{0HB}	V _{IN} = V _{IH}	I _{OHB} =-4mA	1.65	1.3	-	
(B bus)	L-level	V _{0LB}	V _{IN} = V _{IL}	I _{OLB} =4mA	1.65	-	0.2	V
Input leakage currer	nt(DIR,/OE)	I _{IN}	V _{IN} =0 to 3.6 V		1.65 to 2.3		±5.0	μA
Power off leakage	e current	IOFF	A,DIR,/OE=0 to 3.6 V		0	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~	5.0	μA
3-state output off-st	ata aurrant	I _{OZA}		=V _{IH} or V _{IL} =0 to 3.6 V	1.65 to 2.3	2-0	±5.0	μΑ
3-state output on-st	ate current	I _{OZB}		=VIH or VIL =0 or VCC	1.65 to 2.3		±5.0	μA
Quiescent supply current		Icc	VIN=VCC or GND		1.65 to 2.3	<u>り</u>	5.0	μA
Bushold input minimum drive			VIN	V _{IN} ≠0.33 V		20	-	μA
hold current		li(HOLD)		I=1.16 V	1.65	-20	-	μΑ
Bushold input over-drive current		Iver	V _{IN} =	= "L"→"H"	1.95	-	300	μA
to change state	(Note)	II(OD))) V _{IN} =	= "H"→"Ľ"	1.85	-	-300	μΑ

Note: It is a necessary electric current to change the input in "L" or "H".

TOSHIBA

AC Characteristics (Ta=-40 to 85°C,Input: $t_r = t_f = 2.0 \text{ ns}$, $C_L = 30 \text{ pF}$, $R_L = 500 \Omega$)

Parameter	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit
			1.8±0.15	1.0	10.0	
Propagation delay time	t _{pLH} t _{pHL}	Figure 1, Figure 2	2.5±0.2	0.8	4.6	ns
	pric		3.3±0.3	0.6	3.0	
			1.8±0.15		15.0	
3-state output enable time	t _{pZL} t _{pZH}	Figure 1, Figure 3	2.5±0.2	0.8	7.8	ns
			3.3±0.3	0,6	5.6	
			1.8±0.15	1.0	6.5	
3-state output disable time	t _{pLZ} t _{pHZ}	Figure 1, Figure 3	2.5±0.2	0.8	4.3	ns
	-priz		3.3±0.3	0.6	3.9	
			1.8±0.15	- ~	0.5	
Output to output skew	^t osLH ^t osHL	(Note)	2.5±0.2		0.5	ns
	-03HL		3.3±0.3		0.5	

For C_L=50pF, add approximately 300ps to the AC maximum specification.

Note: Parameter guaranteed by design.

 $(t_{osLH} = |t_{pLHm} - t_{pLHn}|, t_{osHL} = |t_{pHLm} - t_{pHLn}|)$

Capacitive Characteristics (Ta=25°c)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Input capacitance	CIN	$\bigcirc \qquad \bigcirc \qquad$	1.8,2.5,3.3	6	pF
Bus I/O capacitance	C _{I/O}		1.8,2.5,3.3	7	pF
Power dissipation capacitance	$(Z \land$	OE= "L", f _{INA} =100MHz Table 1 (Note)	100500	20	pF
(A bus input)	CRDA	OE= "H", fINA=100MHz Table 1 (Note)	1.8,2.5,3.3	0	pF
Power dissipation capacitance		OE= "L", f _{INB} =100MHz Table 1 (Note)	1.8,2.5,3.3	16	pF
(B bus input)	C _{PDB}	OE= "H" , f _{INB} =100MHz Table 1 (Note)	1.0,2.0,3.3	1	pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation.

 $I_{CC(opr)} = C_{PD} \cdot V_{CC} \cdot V_{IN} + I_{CC}/8(per bit)$

Table1 CPD Test Condition

Function										I	Pin									
Function	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20
A bus /OE= "L"	Н	Ρ	Х	х	х	х	х	Х	Х	G	0	0	0	0	6	0	0	С	L	۷
A bus /OE= "H"	Н	Ρ	0	0	0	0	0	0	0	G	0	0	0	0	Ø	Ì	0	0	Н	۷
B bus /OE= "L"	L	С	0	0	0	0	0	0	0	G	х	×ζ	x	X	X	Х	х	Ρ	L	٧
B bus /OE= "H"	L	0	0	0	0	0	0	0	0	G	0	0	0	0	0	0	0	Ρ	Н	۷

Symbol explanation-

 $V = V_{CC}(+3.3V)$

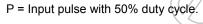
X = Don't care(Fixed to V_{CC} or GND) O = Open

G = GND (0V)

H = Logic 1 (VCC)

C = Connect a condenser(30pF) between output terminal and GND.

L = Logic 0 (GND) P = Input pulse



AC Test Circuit

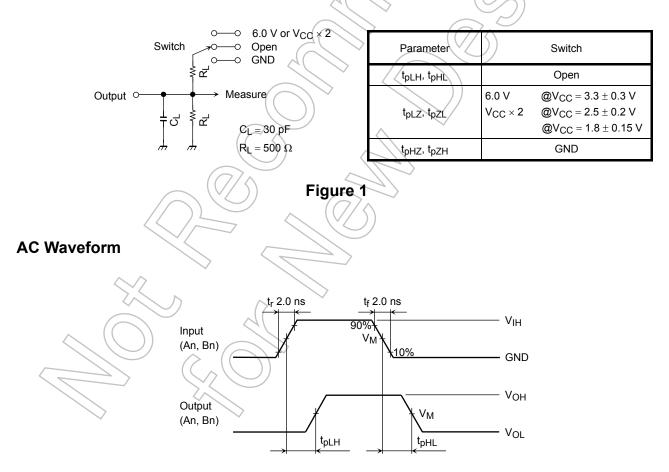


Figure 2 t_{pLH}, t_{pHL}

TC7MP245FK/FTG

TOSHIBA

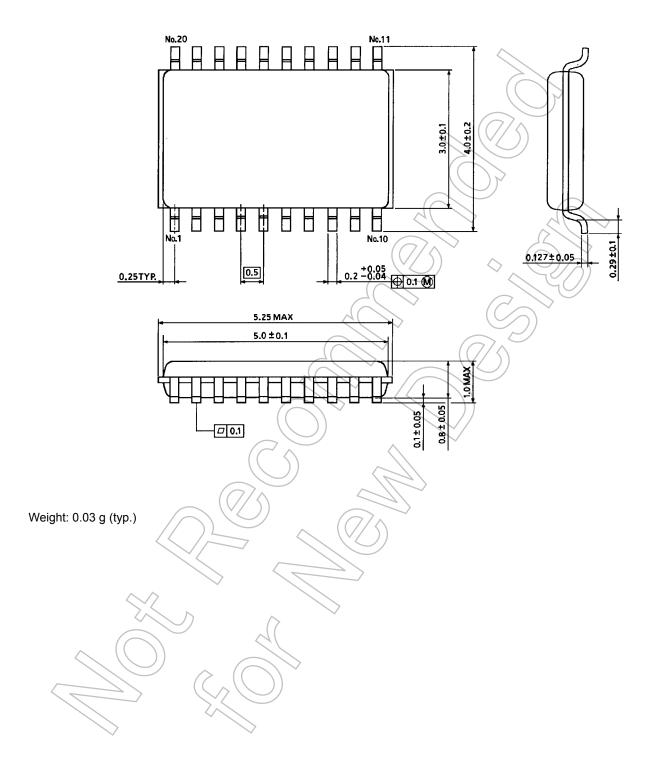
	t _r 2 →	0 ns	t _f 2.0 ns		
Output Enable Control (OE)		f	90% VM 10%		V _{IH} GND
Output (An, Bn) Low to Off to Low		tpLZ tpLZ	x tpz	V _M	
Output (An, Bn) High to Off to High			YY	V _M	V _{OH} GND
	((Dutputs enabled	Outputs disabled	Output enable	s d
				\square	
		Figure 3	t _{pLZ} , t _{pHZ} ,	t _{pZL} , t _{pZH}	
					C
	O makes t		Vcc	\rightarrow	~ 2
	Symbol	3.3±0.3 V	2.5±0.2 V	1.8±0.15 V	7/5
	V _{IH}	2.7 V	Vcc	Vcc	
	VM	1.5 V	Vcc/2	V _{CC} /2	
	VX	V _{OL} + 0.3 V	V _{OL} + 0.15 V	V _{OL} + 0.15 V	/
	VY	V _{OH} - 0.3 V	V _{OH} - 0.15 V	V _{OH} - 0.15 V	

Package Dimensions

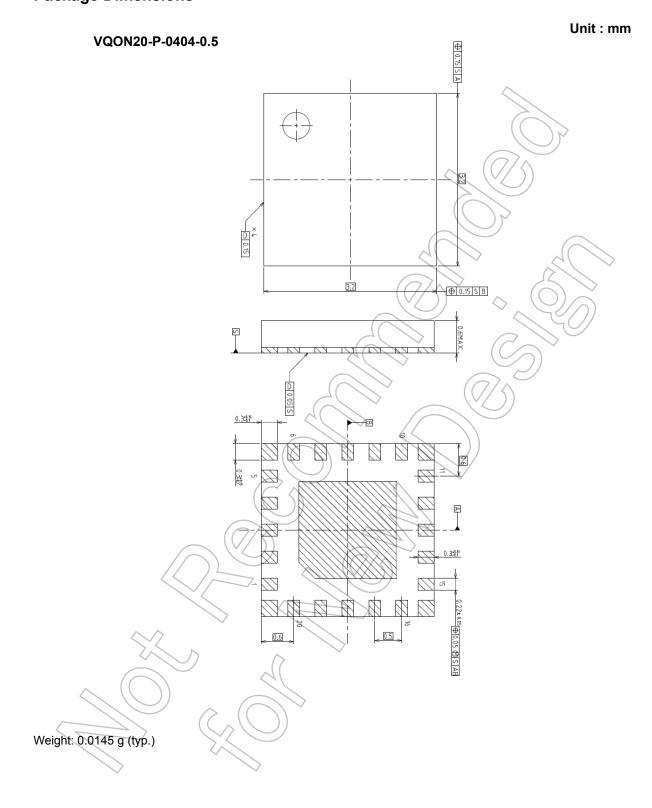
TOSHIBA

VSSOP20-P-0030-0.50

Unit : mm



TOSHIBA Package Dimensions



RESTRICTIONS ON PRODUCT USE

- Toshiba Corporation, and its subsidiaries and affiliates (collectively "TOSHIBA"), reserve the right to make changes to the information in this document, and related hardware, software and systems (collectively "Product") without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.
- PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE EXTRAORDINARILY HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH MAY CAUSE LOSS OF HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT ("UNINTENDED USE"). Except for specific applications as expressly stated in this document, Unintended Use includes, without limitation, equipment used in nuclear facilities, equipment used in the aerospace industry, medical equipment, equipment used for automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to control combustions or explosions, safety devices, elevators and escalators, devices related to electric power, and equipment used in finance-related fields. IF YOU USE PRODUCT FOR UNINTENDED USE, TOSHIBA ASSUMES NO LIABILITY FOR PRODUCT. For details, please contact your TOSHIBA sales representative.
- Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any
 applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND LOSS OF DATA, AND (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO SALE, USE OF PRODUCT, OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). Product and related software and technology may be controlled under the applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.
 Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances,
 including without limitation, the EU RoHS Directive TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES
 OCCURRING AS A RESULT OF NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Bus Transceivers category:

Click to view products by Toshiba manufacturer:

Other Similar products are found below :

 74LS645N
 DS8838
 FXL4TD245UMX
 IDT74CBTLV3257PGG
 74LVT245BBT20-13
 5962-8683401DA
 PCA9617ADMR2G
 5962

 8953501KA
 5962-86834012A
 5962-7802301Q2A
 5962-7802002MFA
 5962-7802001MFA
 74VHCV245FT(BJ)
 NCV7349D13R2G

 TC74VCX164245(EL,F
 MC74LCX245MNTWG
 TC7WPB8306L8X,LF(S
 TC7WPB9307FC(TE85L
 74FCT16245CTPVG8

 74FCT16543CTPVG
 74FCT245CTPYG8
 MM74HC245AMTCX
 74LVCH16245APVG
 74LVX245MTC
 5962-9221405M2A
 NTS0102DP

 Q100H
 74ALVC16245MTDX
 74ALVCH32245BF
 74FCT163245APVG
 74FCT245CTQG
 74FCT3245AQG

 74LCXR162245MTX
 74VHC245M
 TC7WPB9306FC(TE85L
 TC7WPB9306FK(T5L,F
 JM38510/65553BRA
 ST3384EBDR

 74LVC1T45GF,132
 74AVC4TD245BQ,115
 PQJ7980AHN/C0JL,51
 MC100EP16VBDG
 FXL2TD245L10X
 74LVC1T45GM,115

 TC74AC245P(F)
 PSB21150F S LLHR
 SNJ54AHC245J
 SNJ54AHC245J KNJ54AHC245J
 SNJ54AHC245J